

DECLARATION FOR PATENT APPLICATION

As a below named inventor, I hereby declare that my residence, post office address and citizenship are as stated below next to my name; I believe that I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled

ION BEAM DEVICE AND ION BEAM PROCESSING METHOD, as described and claimed in PCT/JP2003/010482 filed AUGUST 20, 2003

the specification of which (check one); ☐ is attached hereto; ☒ was filed on FEBRUARY 22, 2005 as Application Serial No. 10 / 525,311 and was amended on (or amended through) _____ (if applicable). I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment(s) referred to above. I acknowledge the duty to disclose information which is material to the examination of this application in accordance with Title 37, Code of Federal Regulations, §1.56(a). I hereby claim foreign priority benefits under Title 35, United States Code, §119 of any foreign application(s) for patent or inventor's certificate having a filing date before that of the application on which priority is claimed.

Prior Foreign Application(s)

2002-243210 (Number)	Japan (Country)	23 08 2002 (Day/Month/Year Filed)	Priority Claimed	
			<input checked="" type="checkbox"/> Yes	<input type="checkbox"/> No
_____ (Number)	_____ (Country)	_____ (Day/Month/Year Filed)	<input type="checkbox"/> Yes	<input type="checkbox"/> No
_____ (Number)	_____ (Country)	_____ (Day/Month/Year Filed)	<input type="checkbox"/> Yes	<input type="checkbox"/> No
_____ (Number)	_____ (Country)	_____ (Day/Month/Year Filed)	<input type="checkbox"/> Yes	<input type="checkbox"/> No
_____ (Number)	_____ (Country)	_____ (Day/Month/Year Filed)	<input type="checkbox"/> Yes	<input type="checkbox"/> No
_____ (Number)	_____ (Country)	_____ (Day/Month/Year Filed)	<input type="checkbox"/> Yes	<input type="checkbox"/> No

I hereby claim the benefit under Title 35, United States Code, §120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, §112, I acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Regulations, §1.56(a) which occurred between the filing date of the prior application and the national or PCT international filing date of this application:

(Application Serial No.)	(Filing Date)	(Status - Patented, Pending or Abandoned)
_____ (Application Serial No.)	_____ (Filing Date)	_____ (Status - Patented, Pending or Abandoned)

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

POWER OF ATTORNEY

I (we) hereby appoint Bruce L. Adams, Registration No. 25,386, Van C. Wilks, Registration No. 25,027 and Franco S. De Liguori, Registration No. 36,497 whose post office address is: Adams & Wilks, 50 Broadway, 31st Floor, New York, New York 10004, as my (our) attorneys with full power of substitution and revocation, to prosecute this application, and to transact all business in the United States Patent and Trademark Office connected therewith.

Full Name of First or Sole Inventor Toshio KODAMA	Citizenship Japanese
RESIDENCE Address - Street c/o SII NanoTechnology Inc. 8, Nakase 1-chome, Mihama-ku	POST OFFICE Address - Street same as residence address
City (Zip) Chiba-shi, Chiba JPX	City (Zip)
State or Country Japan	State or Country
Date ✓ APRIL 7, 2005	Signature ✓ Toshio Kodama

☒ See second page for additional joint inventors.

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Second Joint Inventor, if any Masakatsu HASUDA	Citizenship Japanese
RESIDENCE Address - Street c/o SII NanoTechnology Inc. 8, Nakase 1-chome, Mihama-ku	POST OFFICE Address - Street same as residence address
City (Zip) Chiba-shi, Chiba JPX	City (Zip)
State or Country Japan	State or Country
Date ✓ APRIL 7, 2005	Signature ✓ <i>M. Hasuda</i>

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Third Joint Inventor, if any Toshiaki FUJII	Citizenship Japanese
RESIDENCE Address - Street c/o SII NanoTechnology Inc. 8, Nakase 1-chome, Mihama-ku	POST OFFICE Address - Street same as residence address
City (Zip) Chiba-shi, Chiba JPX	City (Zip)
State or Country Japan	State or Country
Date ✓ APRIL 7, 2005	Signature ✓ <i>T. Fujii</i>

4-00

Fourth Joint Inventor, if any Kouji IWASAKI	Citizenship Japanese
RESIDENCE Address - Street c/o SII NanoTechnology Inc. 8, Nakase 1-chome, Mihama-ku	POST OFFICE Address - Street same as residence address
City (Zip) Chiba-shi, Chiba JPX	City (Zip)
State or Country Japan	State or Country
Date ✓ APRIL 7, 2005	Signature ✓ <i>Kouji Iwasaki</i>

5-00

Fifth Joint Inventor, if any Yasuhiko SUGIYAMA	Citizenship Japanese
RESIDENCE Address - Street c/o SII NanoTechnology Inc. 8, Nakase 1-chome, Mihama-ku	POST OFFICE Address - Street same as residence address
City (Zip) Chiba-shi, Chiba JPX	City (Zip)
State or Country Japan	State or Country
Date ✓ APRIL 7, 2005	Signature ✓ <i>Yasuhiko Sugiyama</i>

6-00

Sixth Joint Inventor, if any Yasuyuki TAKAGI	Citizenship Japanese
RESIDENCE Address - Street c/o SII NanoTechnology Inc. 8, Nakase 1-chome, Mihama-ku	POST OFFICE Address - Street same as residence address
City (Zip) Chiba-shi, Chiba JPX	City (Zip)
State or Country Japan	State or Country
Date ✓ APRIL 7, 2005	Signature ✓ <i>Yasuyuki Takagi</i>